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United States Design Patent

Okawa et al.

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(54)

SEMICONDUCTOR DEVICE

2924/181; H01L 2924/1811; H01L 2924/1815; H01L 2924/19042; H01L 2924/1905

(71)

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See application file for complete search history.

(72)

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(**)

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U.S. Cl.

USPC D13/182

(58)

Field of Classification Search

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CPC H01L 21/00; H01L 21/02; H01L 21/4814;

H01L 21/4846; H01L 21/4871; H01L 21/67144; H01L 2224/42; H01L 2224/43;

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H01L 2924/171; H01L 2924/1711; H01L 2924/1715; H01L

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(57)

CLAIM

The ornamental design for a semiconductor device, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a semiconductor device showing our new design;

FIG. 2 is a front view thereof;

FIG. 3 is a rear view thereof;

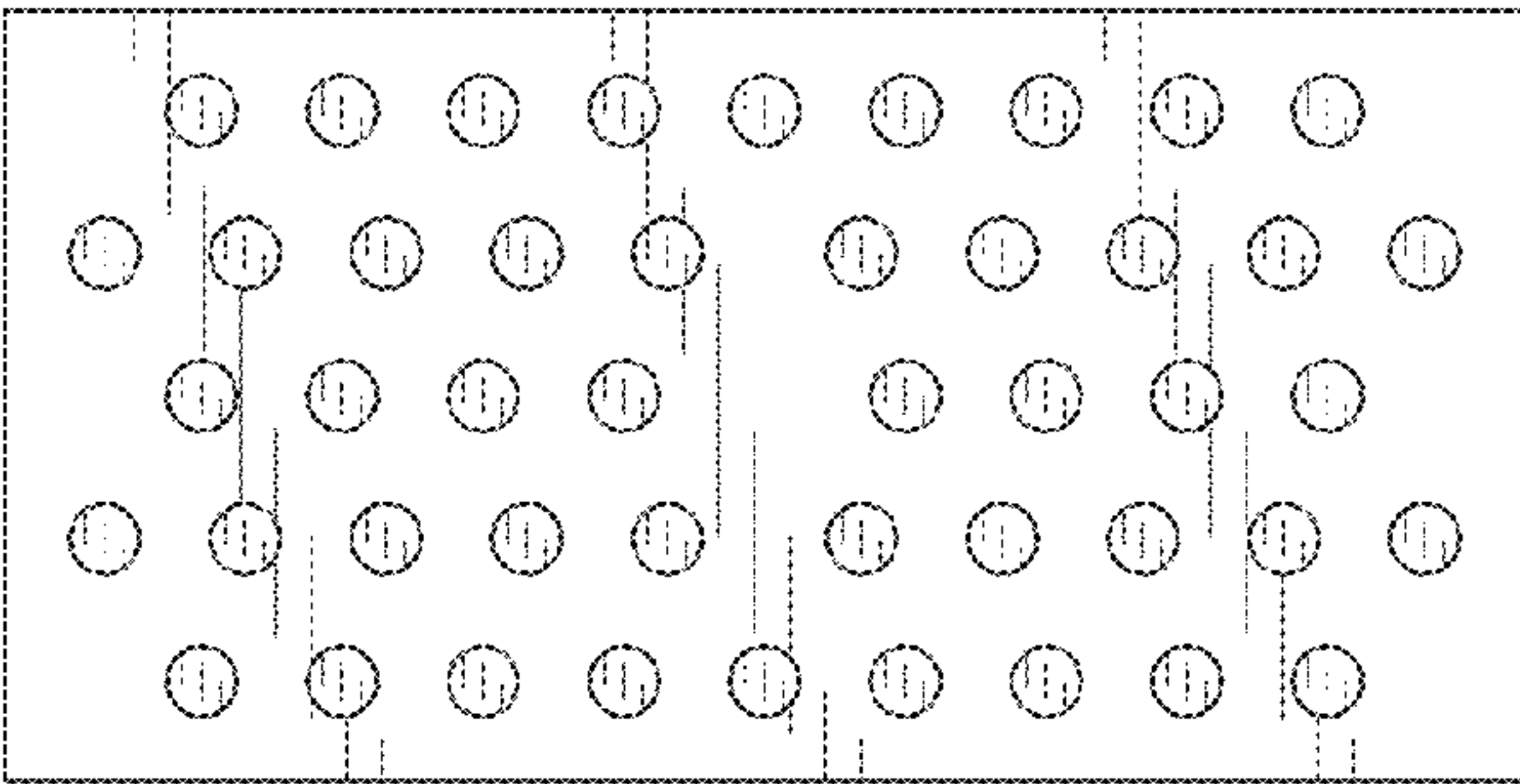
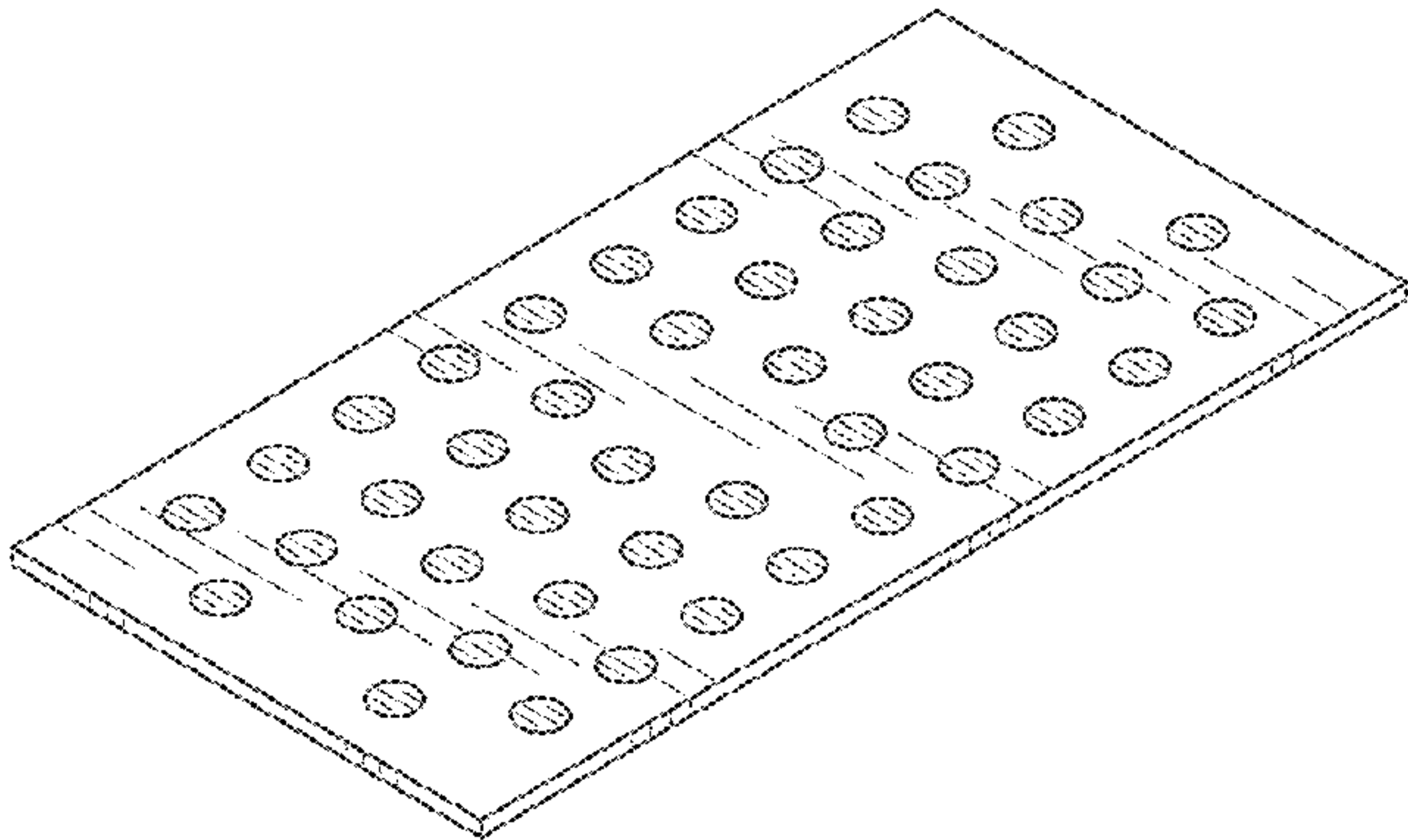
FIG. 4 is a left side view thereof;

FIG. 5 is a right side view thereof;

FIG. 6 is a top plan view thereof; and,

FIG. 7 is a bottom plan view thereof.

1 Claim, 4 Drawing Sheets



(56)

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FIG. 1

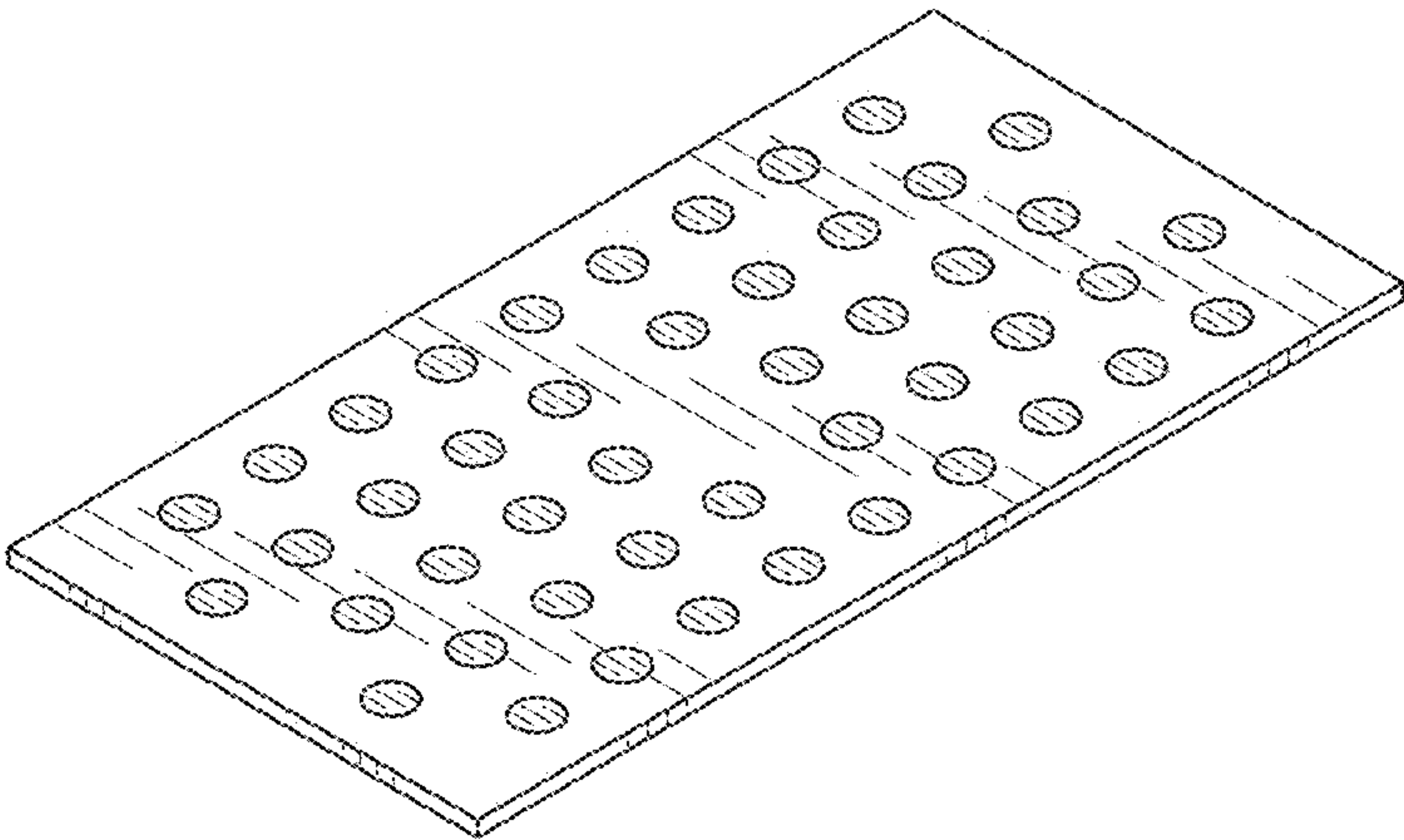


FIG. 2

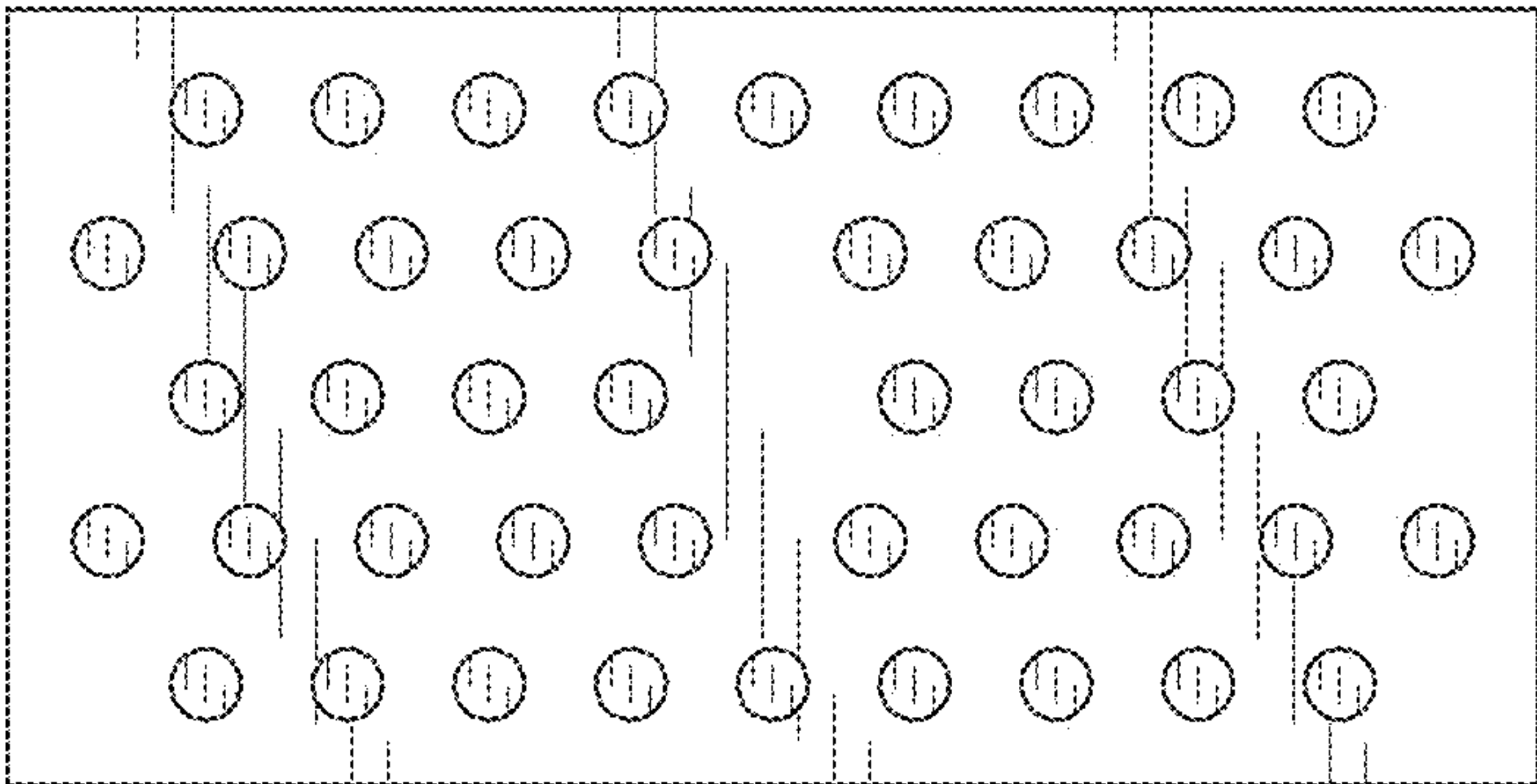


FIG. 3

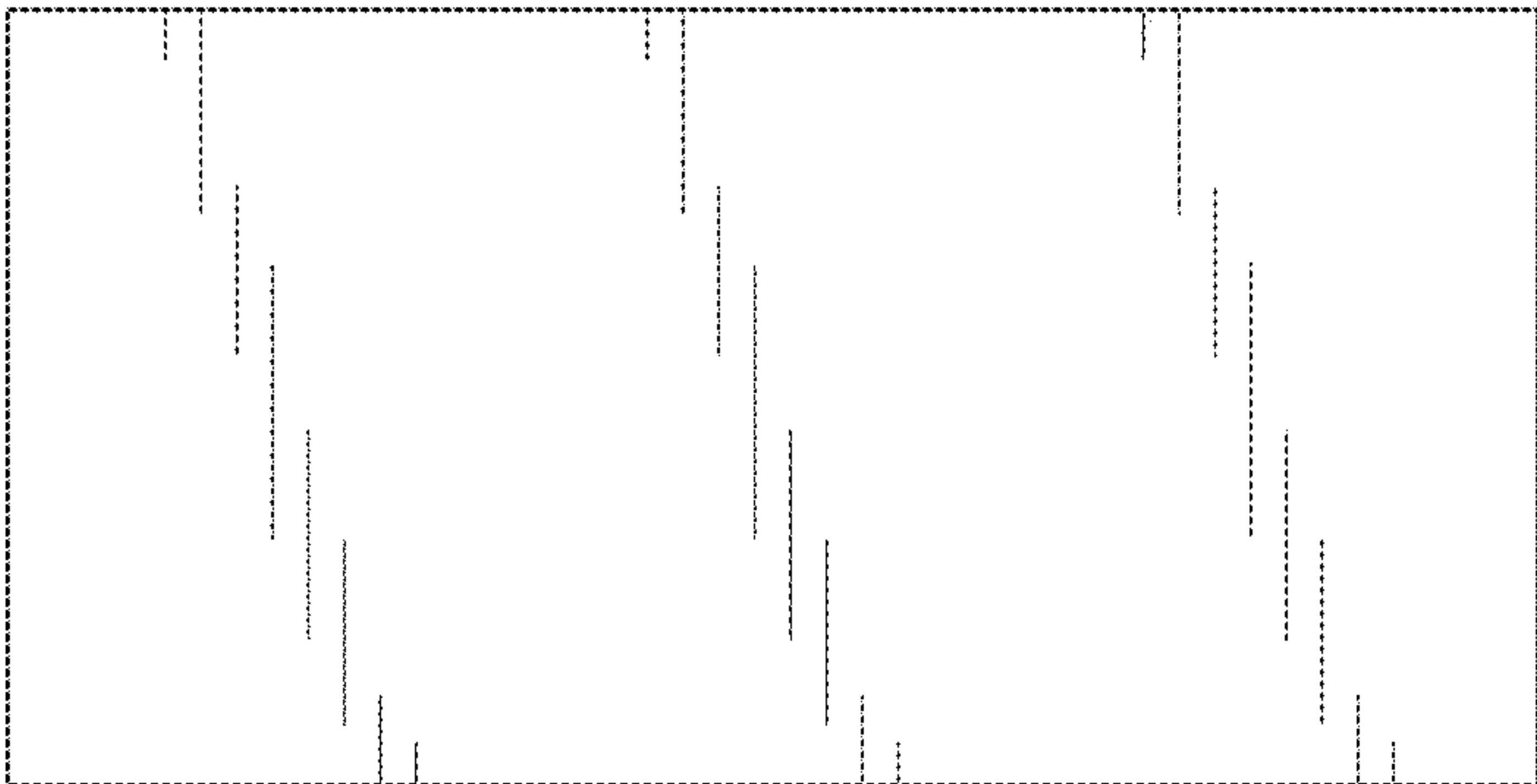


FIG. 4



FIG. 5



FIG. 6



FIG. 7

